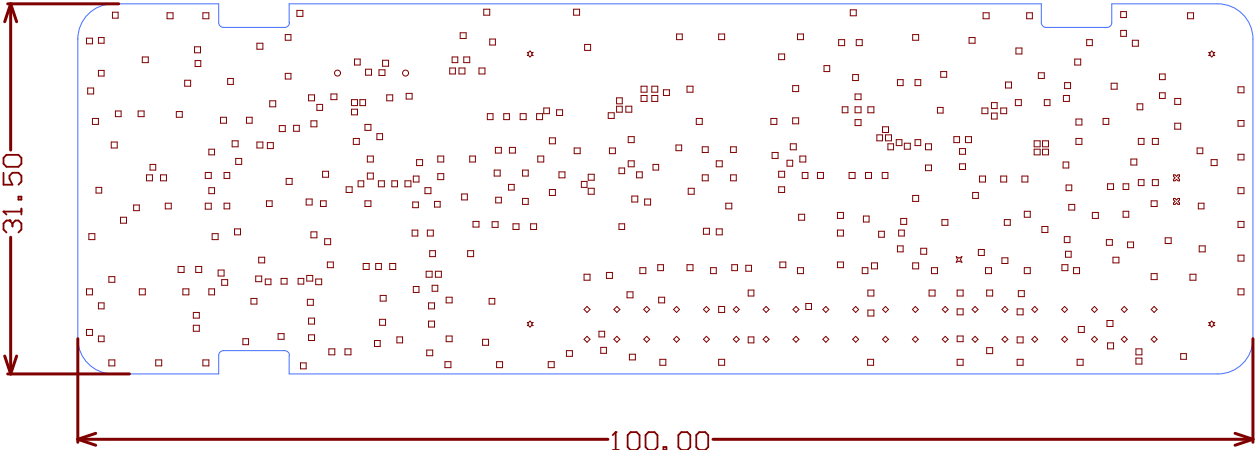


Symbol	Hit Count	Finished Hole Size	Plated	Hole Type
✕	1	2.000mm (78.74mil)	NPTH	Round
○	2	0.650mm (25.59mil)	NPTH	Round
⊠	2	0.800mm (31.50mil)	PTH	Round
☆	4	3.000mm (118.11mil)	NPTH	Round
◇	40	0.970mm (38.19mil)	NPTH	Round
□	393	0.200mm (7.87mil)	PTH	Round
	442 Total			



-PCB Conditions-	
Nmber of Layers	4
Final PCB thickness	1.2mm
Minimum conductor width	0.127mm
Minimum space between conductors	0.127mm
Minimal diam via	0.5
Minimal via drill size	0.2mm
Material	FR4
Copper thickness Top / Bottom	1oz
Copper Thickness Internal layers	1oz
Dimensions	100x31.5mm
Solder Mask Top	YES / GREEN
Solder Mask Bottom	YES / GREEN
Silkscreen top layer	YES / White
Silkscreen bottom layer	YES / White
Component count	208
Hole Count	442
Pad Count	672
Surface Finsih	HASL LF

